

IPC-6012EM

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Medical Applications Addendum to IPC-6012E, *Qualification and Performance Specification for Rigid Printed Boards*

An international standard developed by IPC



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- Show relationship to Design for Manufacturability (DFM) and Design for the Environment (DFE)
- Minimize time to market
- Contain simple (simplified) language
- Just include spec information
- Focus on end product performance
- Include a feedback system on use and problems for future improvement

Standards Should Not:

- Inhibit innovation
- Increase time-to-market
- Keep people out
- Increase cycle time
- Tell you how to make something
- Contain anything that cannot be defended with data

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Developed by the IPC-6012 Medical Addendum Task Group (D-33am)
of the Performance Standards Subcommittee (D-33) of the Rigid Printed
Board Committee (D-30) of IPC

Users of this publication are encouraged to participate in the
development of future revisions.

Contact:

IPC
3000 Lakeside Drive, Suite 105N
Bannockburn, Illinois
60015-1249
Tel 847 615.7100
Fax 847 615.7105

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Acknowledgment

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Rigid Printed Board Committee	IPC-6012 Medical Addendum Task Group	Technical Liaison of the IPC Board of Directors
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Randy Reed R. Reed Consultancy, LLC	Vice Chair Alfred F. Macha AMT Integrated Systems	
IPC-6012 Medical Addendum Task Group		
Thomas Ahrens, Trainalytics GmbH	Emma Hudson, Emma Hudson Technical Consultancy Ltd	James J. Monarchio, TTM Technologies
Michael V. Carano, RBP Chemical Technology, Inc.	Hans-Peter Klein, Dyconex AG	Kathy Nargi-Toth, Bowhead
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